



150mA ULTRA-LOW QUIESCENT CURRENT LDO with ENABLE

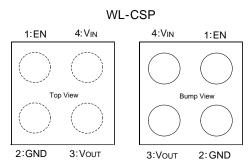
Description

The AP7350 is a low dropout regulator with high output voltage accuracy. The AP7350 includes a voltage reference, error amplifier, current limit circuit and an enable input to turn it on/off. With the integrated resistor network, fixed output voltage versions can be delivered.

With its ultra-low quiescent current and miniature package dimensions, the AP7350 is well suited for low-power handheld, wearable devices, and other battery-operated devices requiring an extended time period until new battery replacement.

The AP7350 is available in the wafer level chip scale WLB0606-4 package. This part is one of the smallest LDO footprints in the industry allowing for the use of a bare minimum of board space within the application.

Pad Assignments



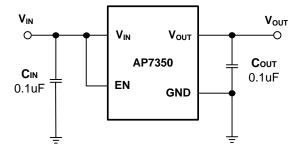
Features

- Low V_{IN} and Wide V_{IN} Range: 2.0 V to 5.25V
- Guarantee Output Current, 150mA
- Output Voltage Range: 1.2 to 4.5V
- V_{OUT} Accuracy: ±1%
- Quiescent Current as Low as 0.25µA
- Typical Standby Current 0.02µA
- ESD Protection Exceeds JESD 22
 - Exceeds 4000-V Human Body Model (A114)
 - Exceeds 400-V Machine Model (A115)
- Latch-Up Exceeds 400mA per JESD 78, Class I
- Totally Lead-Free & and Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Applications

- Wearable Electronics
- Sensor Module for Internet-of-Things (IoT)
- Wireless Communication Module
- Battery-Operated Device
- Camera
- Image Sensor

Typical Applications Circuit (Notes 4 & 5)

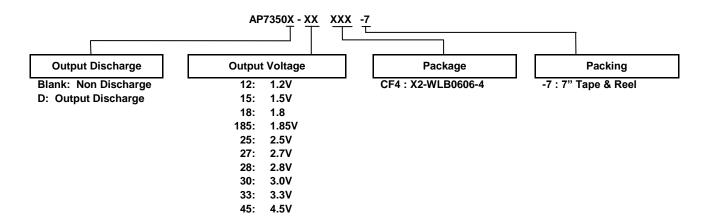


Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green", and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. X5R- and X7R-type capacitors are suggested due to their minimal variation in value and ESR over temperature.
- Avoid light exposure of the chip scale package to maintain the expected electrical performance and functionality of the AP7350.



Ordering Information



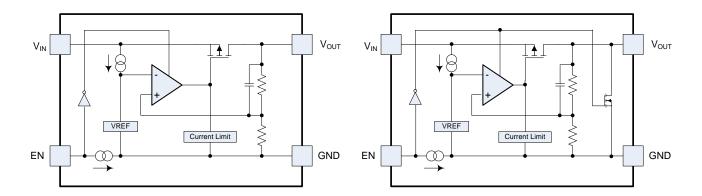
Device	evice Device Output Package		7" Tape and Reel			
Without Discharge	With Discharge	Voltage	Code	Packaging	Quantity	Part Number Suffix
AP7350-12CF4-7	AP7350D-12CF4-7	1.2	CF4	X2-WLB0606-4	3,000/Tape & Reel	-7
AP7350-15CF4-7	AP7350D-15CF4-7	1.5	CF4	X2-WLB0606-4	3,000/Tape & Reel	-7
AP7350-18CF4-7	AP7350D-18CF4-7	1.8	CF4	X2-WLB0606-4	3,000/Tape & Reel	-7
AP7350-185CF4-7	AP7350D-185CF4-7	1.85	CF4	X2-WLB0606-4	3,000/Tape & Reel	-7
AP7350-25CF4-7	AP7350D-25CF4-7	2.5	CF4	X2-WLB0606-4	3,000/Tape & Reel	-7
AP7350-27CF4-7	AP7350D-27CF4-7	2.7	CF4	X2-WLB0606-4	3,000/Tape & Reel	-7
AP7350-28CF4-7	AP7350D-28CF4-7	2.8	CF4	X2-WLB0606-4	3,000/Tape & Reel	-7
AP7350-30CF4-7	AP7350D-30CF4-7	3.0	CF4	X2-WLB0606-4	3,000/Tape & Reel	-7
AP7350-33CF4-7	AP7350D-33CF4-7	3.3	CF4	X2-WLB0606-4	3,000/Tape & Reel	-7
AP7350-45CF4-7	AP7350D-45CF4-7	4.5	CF4	X2-WLB0606-4	3,000/Tape & Reel	-7

Pad Descriptions

Pad Number	Pad Name	Function
1	EN	Channel enable pad. This pad should be driven either high or low and must not be floating. Driving this pad high enables regulator output, while pulling it low enable regulator into shutdown mode.
2	GND	Ground
3	V _{OUT}	Output voltage pad
4	V _{IN}	Power input pad



Functional Block Diagram



AP7350 (without discharge)

AP7350D (with discharge)

Absolute Maximum Ratings (Note 6)

Symbol	Parameter	Rating	Unit
ESD HBM	Human Body Model ESD Protection	4	kV
ESD MM	Machine Model ESD Protection	400	V
V _{IN}	Input Voltage	6.0	V
V _{EN}	Input Voltage at EN pad	6.0	V
V _{оит}	Output Voltage to GND	-0.3 to V _{IN} +0.3	V
TA	Operating Ambient Temperature	-40 to +85	°C
TJ	Maximum Junction Temperature	+125	°C
T _{STG}	Storage Temperature	-55 to +125	°C
P _D	Power Dissipation (Note 7)	315	mW

Notes:

Recommended Operating Conditions

Symbol	Parameter	Min	Max	Unit
VIN	Input Voltage	2.0	5.25	V
I _{OUT}	Output Current	0	150	mA
T _A	Operating Ambient Temperature	-40	+85	°C

^{6.} Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability

^{7.} This is based on an application temperature of 40°C. Derate 3.75 mW per °C for each degree above 40°C.



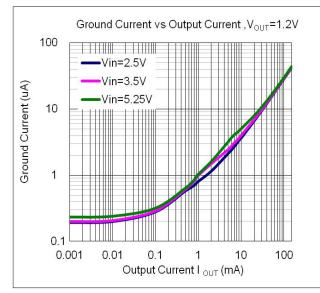
 $\textbf{Electrical Characteristics} \ (@T_A = +25 ^{\circ}\text{C}, \ V_{EN} = V_{IN} = 5.0 \text{V} \ (V_{OUT} > 4.0 \text{V}), \ V_{EN} = V_{IN} = V_{OUT} + 1 \text{V} \ (1.5 \text{V} < V_{OUT} \leq 4.0 \text{V} \), \ V_{EN} = V_{IN} = V_{IN}$ 2.5V (V_{OUT} \leq 1.5V), I_{OUT} = 1mA, C_{IN} = C_{OUT} = 0.1 μ F, unless otherwise specified.)

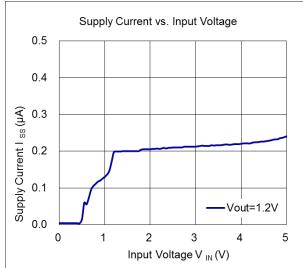
Parameter	Conditions		Min	Тур	Max	Unit
Input Voltage	T _A = -40°C to +85°C		2.0	_	5.25	V
	V _{OUT} > 2.0V I _{OUT} = 1mA	T _A = +25°C	-1	_	+1	- %
		$T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$	-2	_	+2	
Output Voltage Accuracy	$V_{OUT} \le 2.0V$ $I_{OUT} = 1mA$	T _A = +25°C	-40	-	40	mV
		$T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$	-80	-	80	
Line Regulation (ΔV _{OUT} /ΔV _{IN} /V _{OUT})	MAX (V _{OUT} + 1.0V, 2.5V) \leq V _{IN} \leq 5.0V		-	0.02	0.1	%/V
	1 mA ≤I _{OUT} ≤150 mA (all versions except 4.5V)		-25	-	25	mV
Load Regulation (ΔV _{OUT})	1 mA ≤I _{OUT} ≤150 mA	(applicable to 4.5V version)	-45	-	45	mV
Short Circuit Current Limit (Note 8)	V _{OUT} = 0V		-	60	-	mA
Outleasent Current (Note O)		$T_A = +25^{\circ}C$	-	0.25	0.4	μA
Quiescent Current (Note 9)	$I_{OUT} = 0 \text{ mA}$	$T_A = -40$ °C to $+85$ °C	-	-	0.7	μA
ISTANDBY	Set EN low, No load		-	0.02	0.2	μA
Output Current	Vin ≥ V _{OUT} + V _{DROPOUT}		150	-	-	mA
		V _{OUT} = 1.2V	-	0.60	0.90	V
		V _{OUT} = 1.5V	-	0.43	0.75	
		V _{OUT} = 1.8V	-	0.33	0.60	
		V _{OUT} =1.85V	-	0.32	0.58	
Dropout Voltage (Note 10)	1 150 mA	V _{OUT} = 2.5V	-	0.22	0.48	
Dropout Voltage (Note 10)	I _{OUT} = 150 mA	V _{OUT} =2.7V	-	0.21	0.44	
		V _{OUT} =2.8V	-	0.19	0.40	
		V _{OUT} =3.0V	-	0.18	0.35	
		V _{OUT} =3.3V	-	0. 16	0.35	
	V _{OUT} =4.5V		-	0.14	0.35	
Θ _{JA} (Note 11)	Thermal Resistance Junction-to-Ambient Package: X2-WLB0606-4		=	267	-	°C/W
EN Input Low Voltage	-		-	-	0.4	V
EN Input High Voltage	-		1.0	-	5.25	V
Active Output Discharge Resistance	V _{IN} = 4.0V, V _{EN} = 0V		-	35	-	Ω

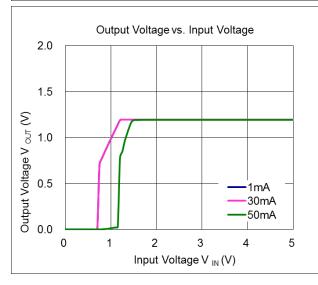
Notes:

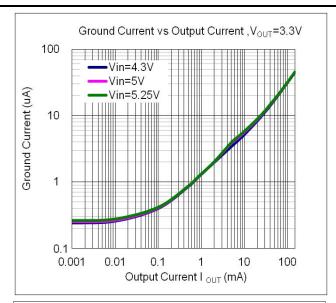
- 8. Short circuit current is measured with VouT pulled to GND.
- S. Guiescent current of heasthed with VOYI patient to GND.
 Quiescent current defined here is the difference in current between the input and the output.
 Dropout voltage is the voltage difference between the input and the output at which the output voltage drops 2% below its nominal value.
 Test condition: WL-CSP is mounted on PCB (compliant with JEDEC standard).
 AP7350 is available with 2 options: built-in discharge (AP7350D) and non-discharge (AP7350).

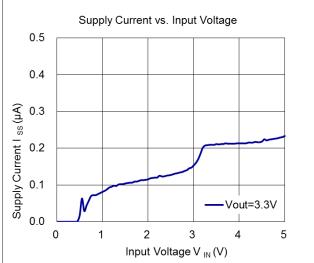


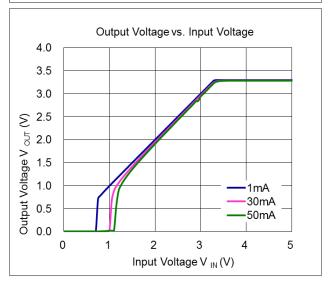




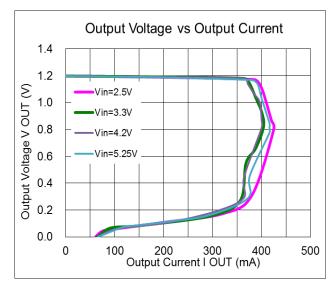


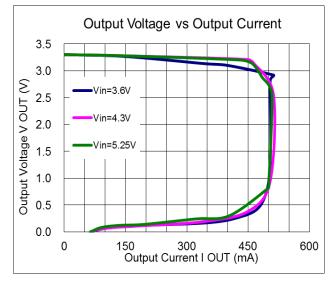


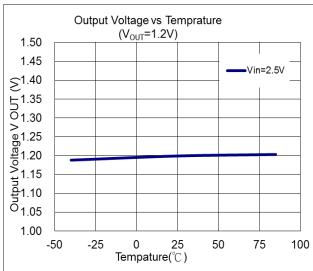


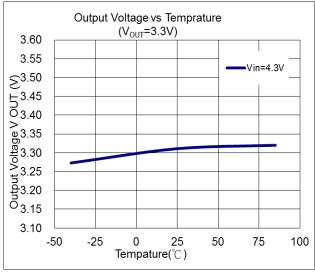


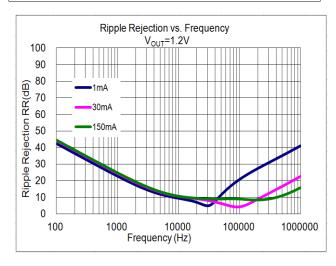


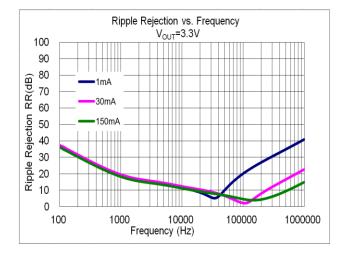






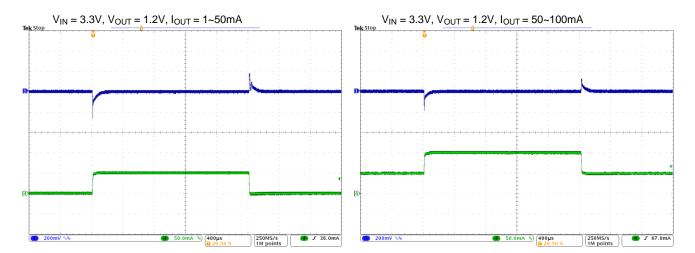


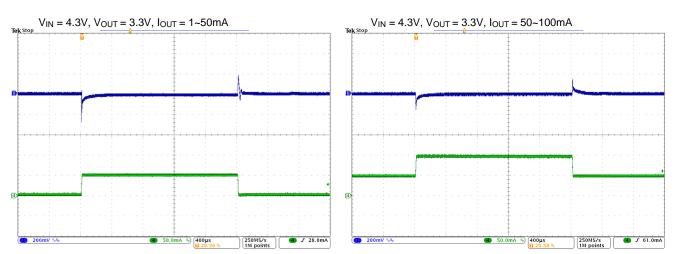




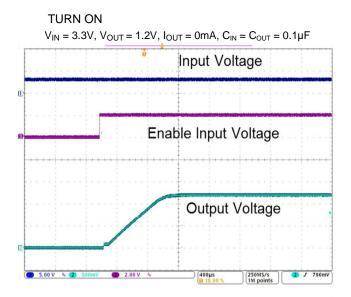


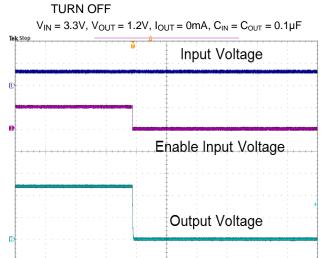
Load Transient Response ($C_{\text{IN}} = C_{\text{OUT}} = 0.1 \mu\text{F}, \, \text{Tr} = \text{Tf} = 5.0 \text{us}, \, \text{unless otherwise specified}$)

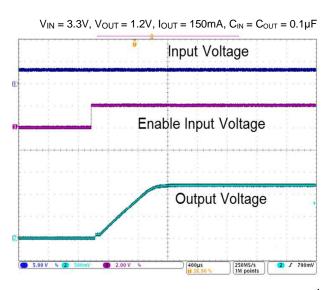


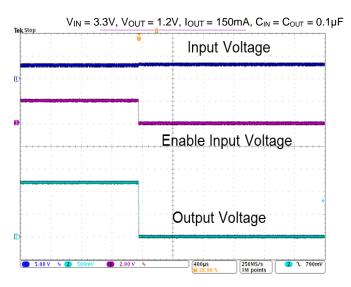


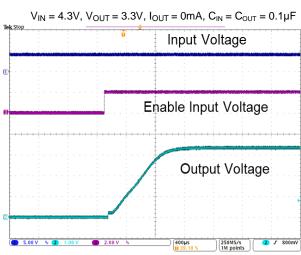


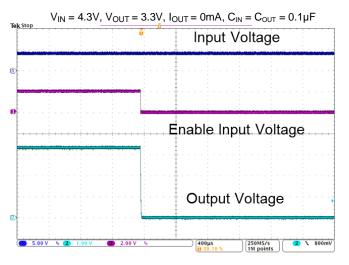






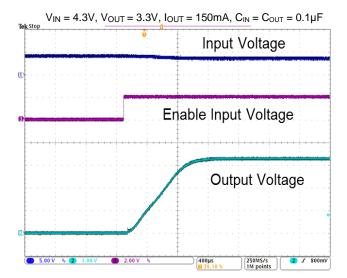




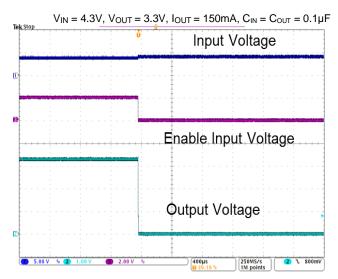




TURN ON



TURN OFF





Application Information

Output Capacitor

An output capacitor (C_{OUT}) is needed to improve transient response and maintain stability. The AP7350 is stable with very small ceramic output capacitors. The ESR (Equivalent Series Resistance) and capacitance drive the selection. If the application has large load variations, it is recommended to utilize low-ESR bulk capacitors. It is recommended to place ceramic capacitors as close as possible to the load and the GND pad and care should be taken to reduce the impedance in the layout.

Input Capacitor

To prevent the input voltage from dropping during load steps, it is recommended to utilize an input capacitor (C_{IN}). A minimum $0.1\mu F$ ceramic capacitor is recommended between V_{IN} and GND pad to decouple input power supply glitch. This input capacitor must be located as close as possible to the device to assure input stability and reduce noise. For PCB layout, a wide copper trace is required for both V_{IN} and GND pad.

Enable Control

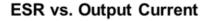
The AP7350 is turned on by setting the EN pad high, and is turned off by pulling it low. If this feature is not used, the EN pad should be tied to V_{IN} pad to keep the regulator output on at all time. To ensure proper operation, the signal source used to drive the EN pad must be able to swing above and below the specified turn-on/off voltage thresholds listed in the Electrical Characteristics section.

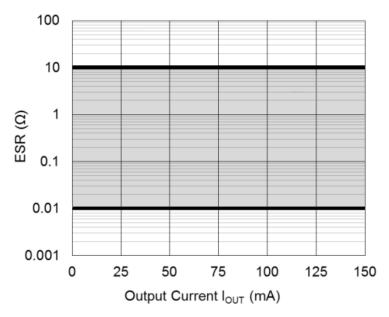
Layout Considerations

For good ground loop and stability, the input and output capacitors should be located close to the input, output, and GND pad of the device. The regulator GND pad should be connected to the external circuit ground to reduce voltage drop caused by trace impedance. Ground plane is generally used to reduce trace impedance. Wide trace should be used for large current paths from V_{IN} to V_{OUT} , and load circuit.

ESR vs. Output Current

A ceramic type output capacitor is recommended for this series; however, the other output capacitors with low ESR also can be used. The relations between I_{OUT} (Output Current) and ESR of an output capacitor are shown below. The stable region is marked as the hatched area in the graph. Measurement conditions: Frequency Band: 10Hz to 2MHz, Temperature: -40°C to +85°C.







Marking Information

(1) X2-WLB0606-4

(Top View)

O X Y W

3.3V

4.5V

X : Identification Code Y : Year : 0~9

W: Week: A~Z: 1~26 week; a~z: 27~52 week; z represents 52 and 53 week

Package Part Number Vout **Identification Code** Α AP7350-12CF4-7 1.2V X2-WLB0606-4 В AP7350-15CF4-7 1.5V X2-WLB0606-4 С AP7350-18CF4-7 1.8V X2-WLB0606-4 R AP7350-185CF4-7 1.85V X2-WLB0606-4 D AP7350-25CF4-7 2.5V X2-WLB0606-4 AP7350-27CF4-7 2.7V X2-WLB0606-4 Ā Ε AP7350-28CF4-7 2.8V X2-WLB0606-4 F AP7350-30CF4-7 3.0V X2-WLB0606-4 G AP7350-33CF4-7 3.3V X2-WLB0606-4 7 AP7350-45CF4-7 4.5V X2-WLB0606-4 Н AP7350D-12CF4-7 1.2V X2-WLB0606-4 J AP7350D-15CF4-7 1.5V X2-WLB0606-4 AP7350D-18CF4-7 1.8V X2-WLB0606-4 Κ AP7350D-185CF4-7 S 1.85V X2-WLB0606-4 L AP7350D-25CF4-7 2.5V X2-WLB0606-4 AP7350D-28CF4-7 2.7 X2-WLB0606-4 В Μ AP7350D-28CF4-7 2.8V X2-WLB0606-4 AP7350D-30CF4-7 Ν 3.0V X2-WLB0606-4

X2-WLB0606-4

X2-WLB0606-4

AP7350D-33CF4-7

AP7350D-45CF4-7

Р

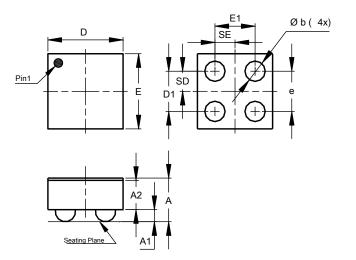
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Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-WLB0606-4

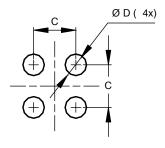


X2-WLB0606-4				
Dim	Min	Max	Тур	
Α	0.300	0.380	0.340	
A1	0.075	0.105	0.090	
A2	0.205	0.255	0.230	
b	0.110	0.190	0.150	
D	0.625	0.655	0.640	
D1	0.300	0.400	0.350	
Е	0.625 0.655 0.640			
E1	0.300 0.400 0.350			
е	0.350 BSC			
SD	0.175 BSC			
SE	0.175 BSC			
All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-WLB0606-4



Dimensions	Value (in mm)	
С	0.350	
D	0.150	

Tape Orientation

 $Note: \quad \text{The taping orientation of the other package type can be found on our website at $http://www.diodes.com/datasheets/ap02007.pdf.} \\$

January 2018



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M38D29FFHP#U1 702103A 717726C 742457H MP20051DN-LF-Z R5F111PGGFB#30 AP7363-SP-13 NCP103AMX285TCG
NCV8664CST33T3G NCV8752AMX28TCG L9454 AP7362-HA-7 LX13043CLD TCR3DF185,LM(CT TCR3DF24,LM(CT
TCR3DF285,LM(CT TCR3DF31,LM(CT TCR3DF45,LM(CT TLF4949EJ L9708 L970813TR 030014BB 059985X EAN61387601
EAN61573601 NCP121AMX173TCG NCP4687DH15T1G NCV8703MX30TCG 701326R 702087BB 755078E TCR2EN28,LF(S
LM1117DT-1.8/NO LT1086CM#TRPBF AZ1085S2-1.5TRE1 MAX15101EWL+T NCV8170AXV250T2G SCD337BTG
TCR3DF27,LM(CT TCR3DF19,LM(CT TCR3DF125,LM(CT TCR2EN18,LF(S MAX15103EWL+T TS2937CZ-5.0 C0 MAX8878EUK30-T MAX663CPA NCV4269CPD50R2G NCV8716MT30TBG AZ1117IH-1.2TRG1 MP2013GQ-P